### General Challenges: Designing for Accuracy TI Precision Labs – Temperature Sensors

**Presented by Daniel Mar** 



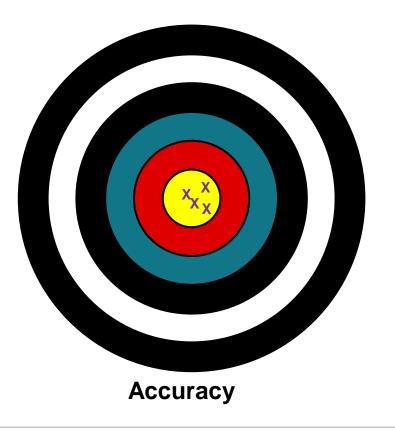
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## **Outline**

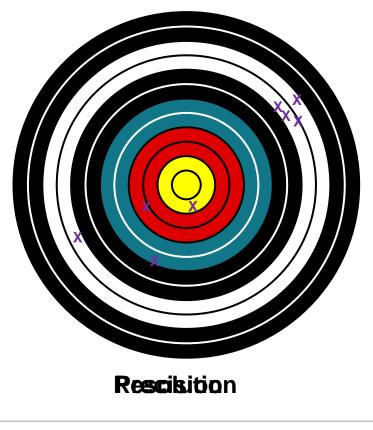
- 1. Understand accuracy
- 2. NTC Accuracy:
  - Understanding Tolerance and Beta
  - Additional error sources
- 3. IC Temperature Sensors Accuracy
- 4. Designing for accuracy
  - Example: Measuring Ambient Air Temperature







VS





# **NTC Thermistor Accuracy**

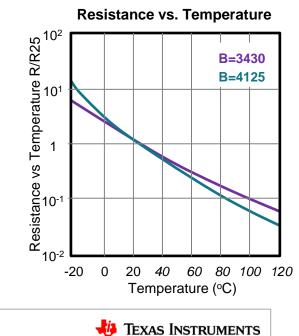
Parameter	Value	
Resistance value at 25 °C	10,000 Ohms	
Tolerance on R25-value	1%	
B25/85-value	3430 to 4125 K	

1% tolerance  $\pi$  1% measurement accuracy

1% tolerance = 1% nominal resistance (at  $25^{\circ}C$ )

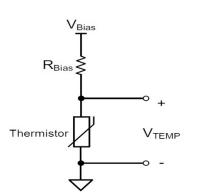
Beta describes the shape of the thermistors curve Variability in beta will drive additional inaccuracy away from 25°C

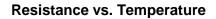


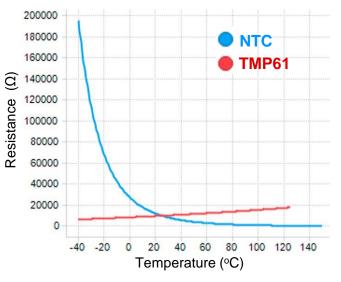


## **Additional Thermistor Error Sources**

- Thermistor isn't the only component
  - R<sub>Bias</sub> : Tolerance & Drift
  - V<sub>Bias</sub>: Noise
  - ADC: LSB
  - ADC: VREF
  - Amplifier (optional)
  - Vcc:







- Linearization error
- Quantization error
- Self-heating

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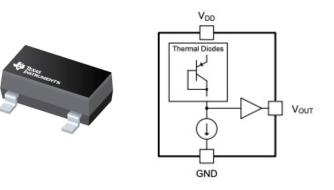


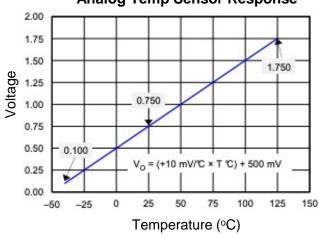
## **IC Temperature Sensors**

• Defined Accuracy:

Accuracy	Typical	Max
0°C to 70°C	0.5°C	1°C
-40°C to 150°C	0.5°C	2°C

- Typical: Expected accuracy
- Max: Worse case accuracy
- Dramatically reduces linearization and quantization error compared to NTC
- · No external components contributing to error
  - Except for ADC if selecting analog output temp sensor
- Minimal self-heating (<5uW with integrated ADC)









# **Optimizing Layout:**

Crucial to achieving an accurate measurement and reducing thermal response time

#### 1. Measurement Objective

• Layout according to objective (ambient air, another component on PCB, body temperature...)

#### 2. Understand the thermal pathways:

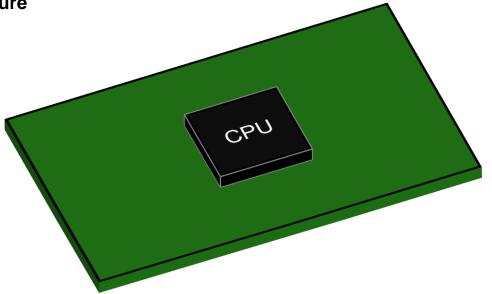
- Heat gain/loss to other components
- · Heat gain/loss to surrounding air and airflow around the sensor
- Radiative Heat Sources
- 3. Reduce thermal resistance to objective and increase thermal resistance to other sources
  - Placing sensor closer to the target, and away from other heat sources
  - Adding or widening metal traces to improve thermal connection
- 4. Reduce thermal mass
  - Improves thermal response time: avoiding lag between the target's temperature and the sensor reaching reaching equilibrium.



### Example

Measurement Objective: Ambient Air Temperature Understand the thermal pathways: Thermal resistance

**Thermal mass** 





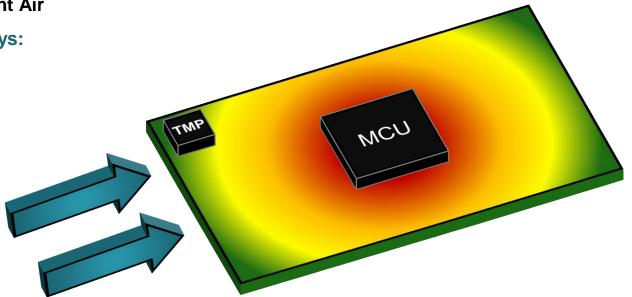
## Example

### Measurement Objective: Ambient Air Understand the thermal pathways:

- Heat Sources
- Air Flow

**Thermal resistance** 

**Thermal mass** 





## Example

#### Measurement Objective: Ambient Air Understand the thermal pathways:

- Heat Sources
- Air Flow

#### **Thermal resistance**

- Conduction thru traces (narrow)
- Conduction thru PCB

#### **Thermal mass**

Minimize mass of sensor and PCB

